## MAGX-000912-125L00





# **GaN on SiC HEMT Pulsed Power Transistor** 125W Peak, 960-1215 MHz, 128µs Pulse, 10% Duty

## **Production V1** 18 Aug 11

#### **Features**

- GaN depletion mode HEMT microwave transistor
- Internally matched
- Common source configuration
- **Broadband Class AB operation**
- **RoHS Compliant**
- +50V Typical Operation
- MTTF of 114 years (Channel Temperature < 200°C)



Avionics: Mode-S, TCAS, JTIDS, DME and TACAN.

## **Product Description**

The MAGX-000912-125L00 is a gold metalized matched Gallium Nitride (GaN) on Silicon Carbide RF power transistor optimized for civilian and military pulsed avionics amplifier applications the 960 MHz to 1215 MHz range such as Mode-S, TCAS, JTIDS, DME and TACAN. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, ruggedness over a wide bandwidth for today's demanding application needs. High breakdown voltages allow for reliable and stable operation in extreme mismatched load conditions unparalleled with older semiconductor technologies.



Freq	Pin	Gain	Slope	ld	Eff	Avg-Eff	RL	Droop
(MHz)	(W)	(dB)	(dB)	(A)	(%)	(%)	(dB)	(dB)
960	1.4	19.7	-	3.9	64.4	-	-6.1	0.3
1030	1.3	19.8	-	4.0	61.6	-	-11.9	0.3
1090	1.6	18.9	-	4.1	60.4	-	-9.6	0.3
1150	1.7	18.6	-	4.1	61.4	-	-9.3	0.3
1215	1.6	18.9	1.2	4.0	61.9	61.9	-12.0	0.3

Typical RF performance measured in M/A-COM RF test fixture. Devices tested in common source Class-AB configuration as follows: Vdd=50V, Idq=100mA (pulsed), F=960-1215 MHz, Pulse=128us, Duty=10%.

#### **Ordering Information**

able. Commitment to produce in volume is

MAGX-000912-125L00 125W GaN Power Transistor MAGX-000912-SB0PPR Evaluation Fixture

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**Absolute Maximum Ratings Table (1, 2, 3)** 

Absolute maximum Ratings Table (1, 2, 5)				
Supply Voltage (V <sub>DD</sub> )	+65V			
Supply Voltage (V <sub>GS</sub> )	-8 to -2V			
Supply Current (I <sub>D MAX</sub> )	7.1 Apk			
Input Power (P <sub>IN</sub> )	+37dBm			
Absolute Max. Junction/Channel Temp	200°C			
MTTF (TJ<200°C)	114 years			
Pulsed Power Dissipation at 85°C	230 Wpk			
Thermal Resistance, (Tj = 70°C) V <sub>DD</sub> = 50V, I <sub>DQ</sub> = 100mA, Pout = 125W 128us Pulse / 10% Duty	0.5°C/W			
Operating Temp	-40 to +95°C			
Storage Temp	-65 to +150°C			
Mounting Temperature	See solder reflow profile			
ESD Min Machine Model (MM)	50V			
ESD Min Human Body Model (HBM)	>250V			
MSL Level	MSL1			

<sup>(1)</sup> Operation of this device above any one of these parameters may cause permanent damage.

<sup>(3)</sup> For saturated performance it recommended that the sum of (3\*Vdd + abs(Vgg)) <175

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units	
DC CHARACTERISTICS							
Drain-Source Leakage Current	V <sub>GS</sub> = -8V, V <sub>DS</sub> = 175V	I <sub>DS</sub>	-	0.2	6	mA	
Gate Threshold Voltage	V <sub>DS</sub> = 5V, I <sub>D</sub> = 15.0mA	V <sub>GS (th)</sub>	-5	-3.8	-2	V	
Forward Transconductance	$V_{DS} = 5V, I_{D} = 3.5 mA$	$G_{M}$	2.5	3.6	-	S	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Not applicable—Input internally matched	C <sub>ISS</sub>	N/A	N/A	N/A	pF	
Output Capacitance	$V_{DS} = 50V, \ V_{GS} = -8V, F = 1MHz$	Coss	-	11	-	pF	
Feedback Capacitance	$V_{DS} = 50V, V_{GS} = -8V, F = 1MHz$	C <sub>RSS</sub>	-	1.1	-	pF	

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<sup>(2)</sup> Channel temperature directly affects a device's MTTF. Channel temperature should be kept as low as possible to maximize lifetime.

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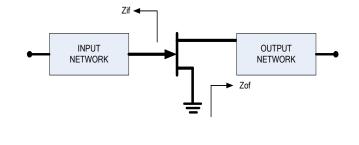
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Electrical Specifications:  $T_C = 25 \pm 5^{\circ}C$  (Room Ambient)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units	
RF FUNCTIONAL TESTS ( $V_{DD}$ = 50V, $I_{DQ}$ = 100mA, 128us / 10% duty, 960-1215MHz)							
Input Power	Pout = 125W Peak (12.5W avg)	P <sub>IN</sub>	-	1.6	2.2	Wpk	
Power Gain	Pout = 125W Peak (12.5W avg)	G <sub>P</sub>	17.5	19.2	-	dB	
Drain Efficiency	Pout = 125W Peak (12.5W avg)	$\eta_{ extsf{D}}$	57	62	-	%	
Load Mismatch Stability	Pout = 125W Peak (12.5W avg)	VSWR-S	5:1	-	-	-	
Load Mismatch Tolerance	Pout = 125W Peak (12.5W avg)	VSWR-T	10:1	-	-	-	

## **Test Fixture Impedance**

F (MHz)	Z <sub>IF</sub> (Ω)	Z <sub>OF</sub> (Ω)
960	3.9 - j7.5	7.6 + j2.6
1030	3.7 - j6.6	8.3 + j1.5
1090	3.6 - j5.6	8.2 + j0.8
1150	4.7 - j6.0	8.0 + j0.6
1215	4.1 - j5.5	8.2 + j0.9



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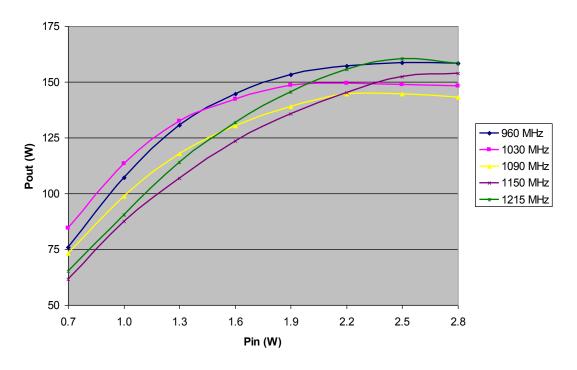
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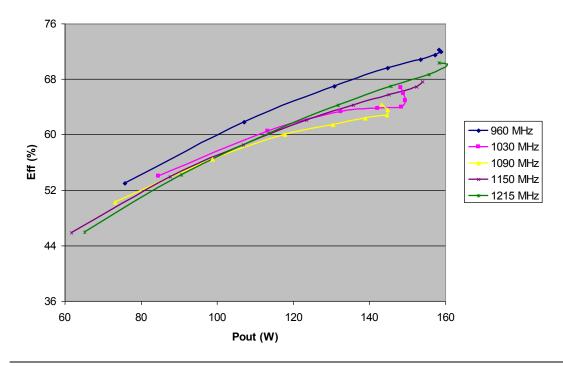


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## RF Power Transfer Curve (Output Power Vs. Input Power)



# RF Power Transfer Curve (Drain Efficiency Vs. Output Power)



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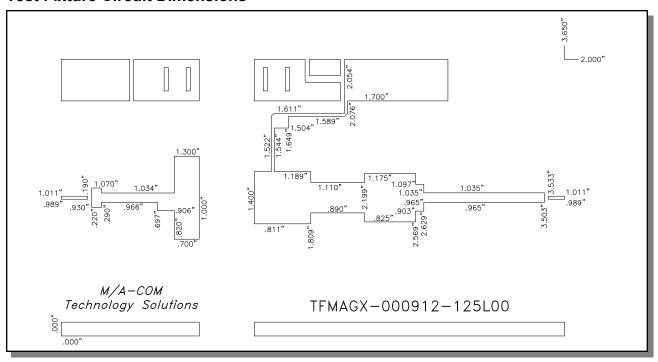
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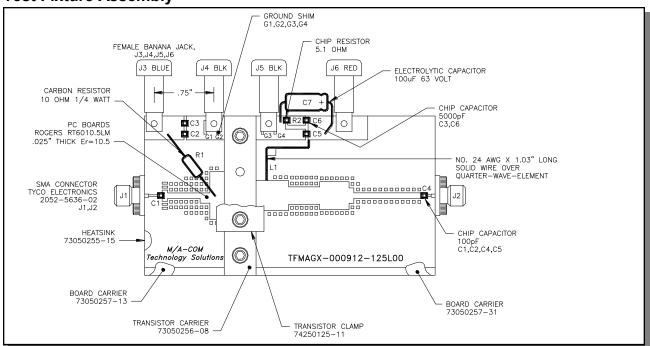
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## **Test Fixture Circuit Dimensions**



## **Test Fixture Assembly**



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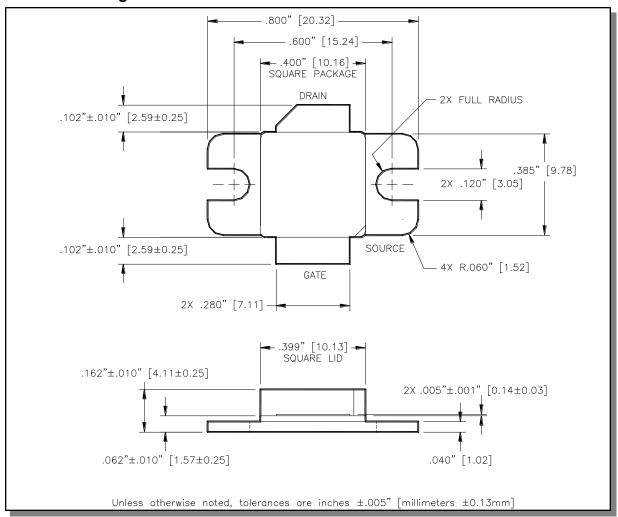
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## **Outline Drawing**



### CORRECT DEVICE SEQUENCING

### TURNING THE DEVICE ON

- 1. Set  $V_{GS}$  to the pinch-off  $(V_P)$ , typically -5V
- 2. Turn on V<sub>DS</sub> to nominal voltage (50V)
- 3. Increase V<sub>GS</sub> until the I<sub>DS</sub> current is reached
- 4. Apply RF power to desired level

### TURNING THE DEVICE OFF

- 1. Turn the RF power off
- 2. Decrease  $V_{\text{GS}}$  down to  $V_{\text{P}}$
- 3. Decrease V<sub>DS</sub> down to 0V
- 4. Turn off V<sub>GS</sub>

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